Octal Buffer/Line Driver with 3-State Outputs

The SN74LS240 and SN74LS244 are Octal Buffers and Line Drivers designed to be employed as memory address drivers, clock drivers and bus-oriented transmitters/receivers which provide improved PC board density.

- Hysteresis at Inputs to Improve Noise Margins
- 3-State Outputs Drive Bus Lines or Buffer Memory Address Registers
- Input Clamp Diodes Limit High-Speed Termination Effects



ON Semiconductor

Formerly a Division of Motorola http://onsemi.com

> LOW POWER SCHOTTKY

GUARANTEED OPERATING RANGES

Symbol	Parameter	Min	Тур	Max	Unit
V _{CC}	Supply Voltage	4.75	5.0	5.25	V
T _A	Operating Ambient Temperature Range	0	25	70	°C
I _{OH}	Output Current – High			-3.0	mA
				-15	mA
I _{OL}	Output Current – Low			24	mA





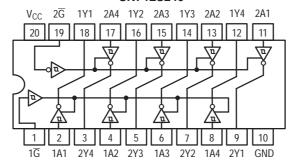
SOIC DW SUFFIX CASE 751D

ORDERING INFORMATION

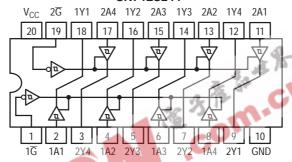
Device	Package	Shipping		
SN74LS240N	16 Pin DIP	1440 Units/Box		
SN74LS240DW	16 Pin	2500/Tape & Reel		
SN74LS244N	16 Pin DIP	1440 Units/Box		
SN74LS244DW	16 Pin	2500/Tape & Reel		

LOGIC AND CONNECTION DIAGRAMS DIP (TOP VIEW)

SN74LS240



SN74LS244



TRUTH TABLES

SN74LS240

INP	ОИТРИТ	
1 G , 2 G		
L	L	Н
L	Н	L
Н	X	(Z)

SN74LS244

INP	OUTPUT		
1 G , 2 G	D	OUTPUT	
L	L	L	
L	Н	Н	
Н	X	(Z)	

H = HIGH Voltage Level L = LOW Voltage Level X = Immaterial Z = HIGH Impedance

DC CHARACTERISTICS OVER OPERATING TEMPERATURE RANGE (unless otherwise specified)

		Limits					
Symbol	Parameter	Min	Тур	Max	Unit	Test Conditions	
V _{IH}	Input HIGH Voltage	2.0			V	Guaranteed Input HIGH Voltage for All Inputs	
V _{IL}	Input LOW Voltage			0.8	V	Guaranteed Input LOW Voltage for All Inputs	
$V_{T+}-V_{T-}$	Hysteresis	0.2	0.4		V	V _{CC} = MIN	
V _{IK}	Input Clamp Diode Voltage		-0.65	-1.5	V	$V_{CC} = MIN, I_{IN} =$	–18 mA
V _{OH}	Output HIGH Voltage	2.4	3.4		V	$V_{CC} = MIN, I_{OH} = -3.0 \text{ mA}$	
VOH	Output HIGH Voltage	2.0			V	V _{CC} = MIN, I _{OH} = MAX	
.,	0		0.25	0.4	V	I _{OL} = 12 mA	$V_{CC} = V_{CC} MIN,$
V _{OL}	Output LOW Voltage		0.35	0.5	V	I _{OL} = 24 mA	V _{IN} = V _{IL} or V _{IH} per Truth Table
l _{ozh}	Output Off Current HIGH			20	μΑ	V _{CC} = MAX, V _{OUT} = 2.7 V	
I _{OZL}	Output Off Current LOW			-20	μА	V _{CC} = MAX, V _{OUT} = 0.4 V	
				20	μА	$V_{CC} = MAX, V_{IN}$	= 2.7 V
¹ıн	Input HIGH Current			0.1	mA	$V_{CC} = MAX, V_{IN} = 7.0 V$	
I _{IL}	Input LOW Current			-0.2	mA	V _{CC} = MAX, V _{IN} = 0.4 V	
Ios	Output Short Circuit Current (Note 1)	-40		-225	mA	V _{CC} = MAX	
	Power Supply Current Total, Output HIGH		3	27	OW		
I _{CC}	Total, Output LOW LS240			44		l	
	LS244			46	mA	$V_{CC} = MAX$	
	Total at HIGH Z LS240			50			
	LS244			54			

Note 1: Not more than one output should be shorted at a time, nor for more than 1 second.

AC CHARACTERISTICS $(T_A = 25^{\circ}C, V_{CC} = 5.0 \text{ V})$

		Limits				
Symbol	Parameter	Min	Тур	Max	Unit	Test Conditions
t _{PLH} t _{PHL}	Propagation Delay, Data to Output LS240		9.0 12	14 18	ns	
t _{PLH} t _{PHL}	Propagation Delay, Data to Output LS244		12 12	18 18	ns	$C_L = 45 \text{ pF},$ $R_L = 667 \Omega$
t _{PZH}	Output Enable Time to HIGH Level		15	23	ns	
t _{PZL}	Output Enable Time to LOW Level		20	30	ns	
t _{PLZ}	Output Disable Time from LOW Level		15	25	ns	C _L = 5.0 pF,
t _{PHZ}	Output Disable Time from HIGH Level		10	18	ns	$R_L = 667 \Omega$

AC WAVEFORMS

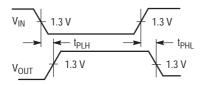


Figure 1.

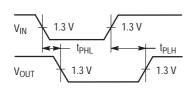
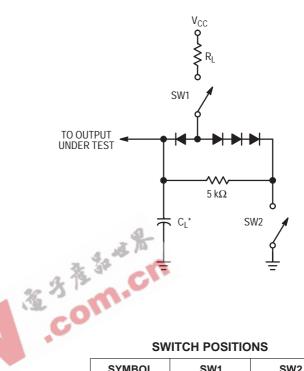


Figure 2.



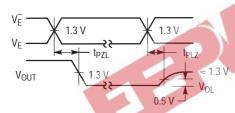


Figure 3.

SWITCH POSITIONS

•						
SYMBOL	SW1	SW2				
t _{PZH}	Open	Closed				
t _{PZL}	Closed	Open				
t _{PLZ}	Closed	Closed				
t _{PHZ}	Closed	Closed				

Figure 5.

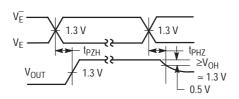
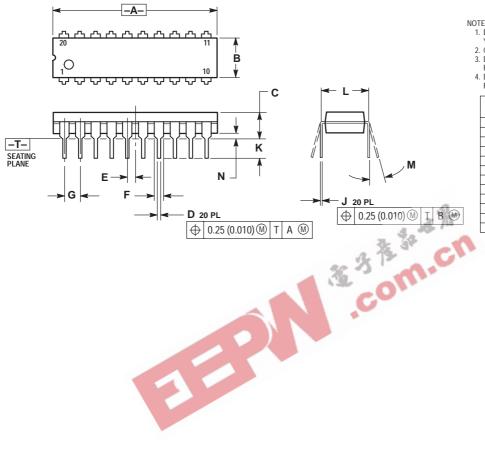


Figure 4.

PACKAGE DIMENSIONS

N SUFFIX PLASTIC PACKAGE

CASE 738-03 **ISSUE E**



NOTES:

- IOTES:

 1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.

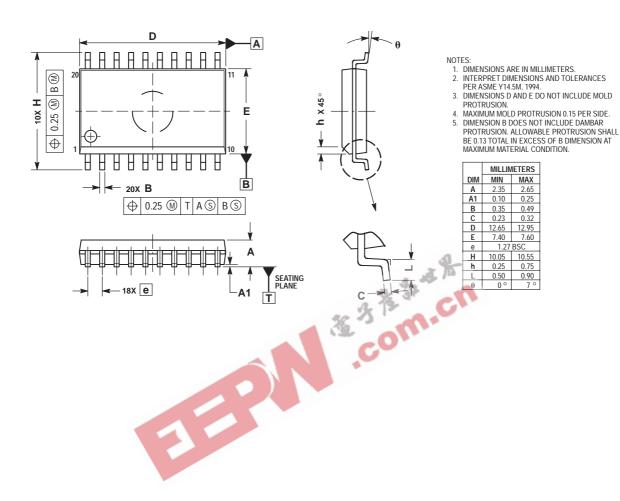
 2. CONTROLLING DIMENSION: INCH.

 3. DIMENSION L TO CENTER OF LEAD WHEN FORMED PARALLEL.

 4. DIMENSION B DOES NOT INCLUDE MOLD FLASH.

	INC	HES	MILLIN	IETERS
DIM	MIN	MAX	MIN	MAX
Α	1.010	1.070	25.66	27.17
В	0.240	0.260	6.10	6.60
С	0.150	0.180	3.81	4.57
D	0.015	0.022	0.39	0.55
Ε	0.050 BSC		1.27 BSC	
F	0.050	0.070	1.27	1.77
G	0.100 BSC		2.54	BSC
J	0.008	0.015	0.21	0.38
K	0.110	0.140	2.80	3.55
L	0.300 BSC		7.62	BSC
M	0 °	15°	0°	15°
N	0.020	0.040	0.51	1.01

D SUFFIX PLASTIC SOIC PACKAGE CASE 751D-05 ISSUE F



Notes





ON Semiconductor and are trademarks of Semiconductor Components Industries, LLC (SCILLC). SCILLC reserves the right to make changes without further notice to any products herein. SCILLC makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does SCILLC assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. "Typical" parameters which may be provided in SCILLC data sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. SCILLC does not convey any license under its patent rights nor the rights of others. SCILLC products are not designed, intended, or authorized for use as components in systems intended for surgical implant into the body, or other applications intended to support or sustain life, or for any other application in which the failure of the SCILLC product could create a situation where personal injury or death may occur. Should Buyer purchase or use SCILLC products for any such unintended or unauthorized application, Buyer shall indemnify and hold SCILLC and its officers, employees, subsidiaries, affiliates, and distributors harmless against all claims, costs, damages, and expenses, and reasonable attorney fees arising out of, directly or indirectly, any claim of personal injury or death associated with such unintended or unauthorized use, even if such claim alleges that SCILLC was negligent regarding the design or manufacture of the part. SCILLC is an Equal Opportunity/Affirmative Action Employer.

PUBLICATION ORDERING INFORMATION

North America Literature Fulfillment:

Literature Distribution Center for ON Semiconductor P.O. Box 5163, Denver, Colorado 80217 USA

Phone: 303–675–2175 or 800–344–3860 Toll Free USA/Canada **Fax**: 303–675–2176 or 800–344–3867 Toll Free USA/Canada

Email: ONlit@hibbertco.com

N. American Technical Support: 800–282–9855 Toll Free USA/Canada

EUROPE: LDC for ON Semiconductor - European Support

German Phone: (+1) 303–308–7140 (M–F 2:30pm to 5:00pm Munich Time)

Email: ONlit-german@hibbertco.com

French Phone: (+1) 303–308–7141 (M–F 2:30pm to 5:00pm Toulouse Time)

Email: ONlit-french@hibbertco.com

English Phone: (+1) 303-308-7142 (M-F 1:30pm to 5:00pm UK Time)

Email: ONlit@hibbertco.com

ASIA/PACIFIC: LDC for ON Semiconductor – Asia Support

Phone: 303–675–2121 (Tue–Fri 9:00am to 1:00pm, Hong Kong Time)

Toll Free from Hong Kong 800–4422–3781

Email: ONlit-asia@hibbertco.com

JAPAN: ON Semiconductor, Japan Customer Focus Center 4–32–1 Nishi–Gotanda, Shinagawa–ku, Tokyo, Japan 141–8549

Phone: 81–3–5487–8345 Email: r14153@onsemi.com

Fax Response Line: 303-675-2167

800-344-3810 Toll Free USA/Canada

ON Semiconductor Website: http://onsemi.com

For additional information, please contact your local

Sales Representative.